

# Amplifier, Power, 20W 7.5-10.5 GHz

## **Features**

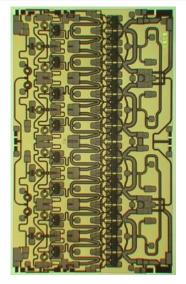
- 17 Watt Saturated Output Power Level
- 20 Watt Saturated Output Power Level over 8-10 GHz Band
- Variable Drain Voltage (8-10V) Operation
- ♦ MSAG<sup>™</sup> Process
- Robust Stability

## Description

The MAAPGM0079-DIE is a 3 stage 20W power amplifier with on-chip bias networks. This product is fully matched to 50 ohms on both the input and output. It can be used as a power amplifier stage or as a driver stage in high power applications.

Fabricated using M/A-COM's repeatable, high performance and highly reliable GaAs Multifunction Self-Aligned Gate (MSAG)Process, each device is 100% RF tested on wafer to ensure performance compliance.

M/A-COM's MSAG process features robust silicon-like manufacturing processes, planar processing of ion implanted transistors, multiple implant capability enabling power, low-noise, switch and digital FETs on a single chip, and polyimide scratch protection for ease of use with automated manufacturing processes. The use of refractory metals and the absence of platinum in the gate metal formulation prevents hydrogen poisoning when employed in hermetic packaging.



## **Primary Applications**

- SatCom
- Commercial Avionics
- Radar

# Also Available in:

| Description | Ceramic Package    | Sample Board (Die) | Sample Board (Pkg) | Mechanical Sample (Die) |
|-------------|--------------------|--------------------|--------------------|-------------------------|
| Part Number | MAAP-000079-PKG001 | MAAP-000079-SMB004 | MAAP-000079-SMB001 | MAAP-000079-MCH000      |

### Electrical Characteristics: $T_B = 40^{\circ}C^1$ , $Z_0 = 50 \Omega$ , $V_{DD} = 10V$ , $I_{DQ} = 4A^2$ , $P_{in} = 18 \text{ dBm}$ , $R_g = 20 \Omega$

| Parameter   | Symbol           | Typical  | Units |
|---|------------------|----------|-------|
| Bandwidth   | f                | 7.5-10.5 | GHz   |
| Output Power  | P <sub>OUT</sub> | 42       | dBm   |
| Output Power, 8-10 GHz                              | P <sub>OUT</sub> | 43       | dBm   |
| 1-dB Compression Point                              | P1dB             | 42       | dBm   |
| Small Signal Gain                                   | G                | 29       | dB    |
| Power Added Efficiency                              | PAE              | 30       | %     |
| Input VSWR  | VSWR             | 2.5:1    |       |
| Output VSWR   | VSWR             | 2.5:1    |       |
| Gate Current  | I <sub>GG</sub>  | 50       | mA    |
| Drain Current, under RF Drive                       | I <sub>DD</sub>  | 6        | A     |
| Output Third Order Intercept                        | TOI              | 48       | dBm   |
| Output Third Order Intermod,<br>Pout = 39 dBm (DCL) | IM3              | 18.5     | dBc   |

1. T<sub>B</sub> = MMIC Base Temperature

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2. Adjust  $V_{GG}$  between –2.6 and –1.5V to achieve specified Idq.

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#### MAAPGM0079-DIE Rev A

Preliminary Datasheet



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#### MAAPGM0079-DIE Rev A Preliminary Datasheet

## Maximum Ratings<sup>3</sup>

| Parameter                             | Symbol            | Absolute Maximum | Units |
|---------------------------------------|-------------------|------------------|-------|
| Input Power                           | P <sub>IN</sub>   | 23               | dBm   |
| Drain Supply Voltage                  | V <sub>DD</sub>   | +12.0            | V     |
| Gate Supply Voltage                   | $V_{GG}$          | -3.0             | V     |
| Quiescent Drain Current (No RF)       | I <sub>DQ</sub>   | 6.6              | А     |
| Quiescent DC Power Dissipated (No RF) | P <sub>DISS</sub> | 65.8             | W     |
| Junction Temperature                  | TJ                | 170              | C°    |
| Storage Temperature                   | T <sub>STG</sub>  | -55 to +150      | C°    |

3. Operation beyond these limits may result in permanent damage to the part.

# **Recommended Operating Conditions<sup>4</sup>**

| Characteristic        | Symbol          | Min  | Тур  | Max    | Unit |
|-----------------------|-----------------|------|------|--------|------|
| Drain Voltage         | V <sub>DD</sub> | 4.0  | 10.0 | 10.0   | V    |
| Gate Voltage          | $V_{GG}$        | -2.6 | -2.2 | -1.5   | V    |
| Input Power           | P <sub>IN</sub> |      | 18.0 | 21.0   | dBm  |
| Thermal Resistance    | Θ <sub>JC</sub> |      | 2.2  |        | °C/W |
| MMIC Base Temperature | Τ <sub>Β</sub>  |      |      | Note 5 | °C   |

4. Operation outside of these ranges may reduce product reliability.

5. MMIC Base Temperature =  $170^{\circ}C - \Theta_{JC} * V_{DD} * I_{DQ}$ 



# **Operating Instructions**

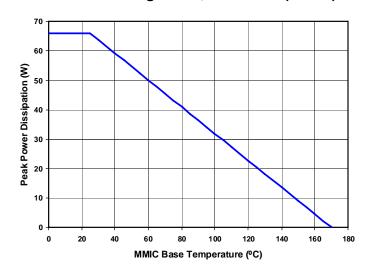
This device is static sensitive. Please handle with care. To operate the device, follow these steps.

- 1. Apply  $V_{GG}$  = -2.7 V,  $V_{DD}$ = 0 V.
- 2. Ramp  $V_{DD}$  to desired voltage, typically 10.0 V.
- 3. Adjust V<sub>GG</sub> to set  $I_{DQ}$ , (approximately @ –2.2 V).
- 4. Set RF input.

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5. Power down sequence in reverse. Turn  $V_{GG}$  off last.

## Power Derating Curve, Quiescent (No RF)



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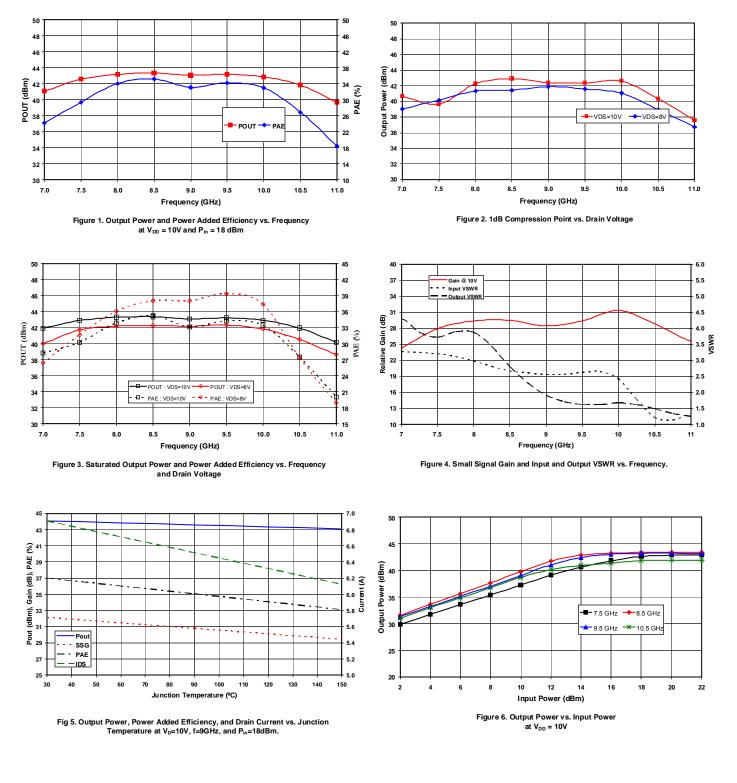
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#### MAAPGM0079-DIE Rev A Preliminary Datasheet



#### All Data is at 40°C MMIC base temperature, CW stimulus, unless otherwise noted.

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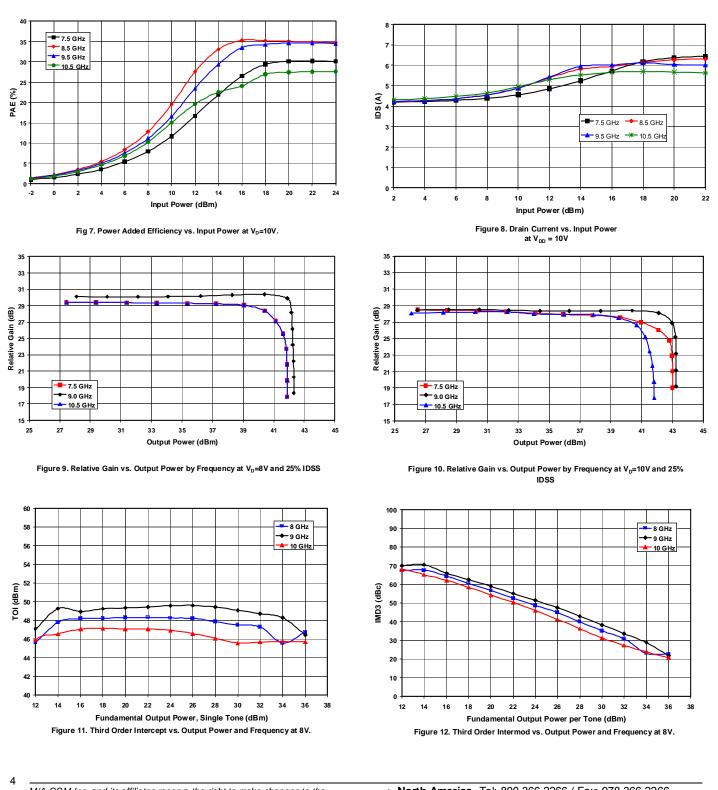
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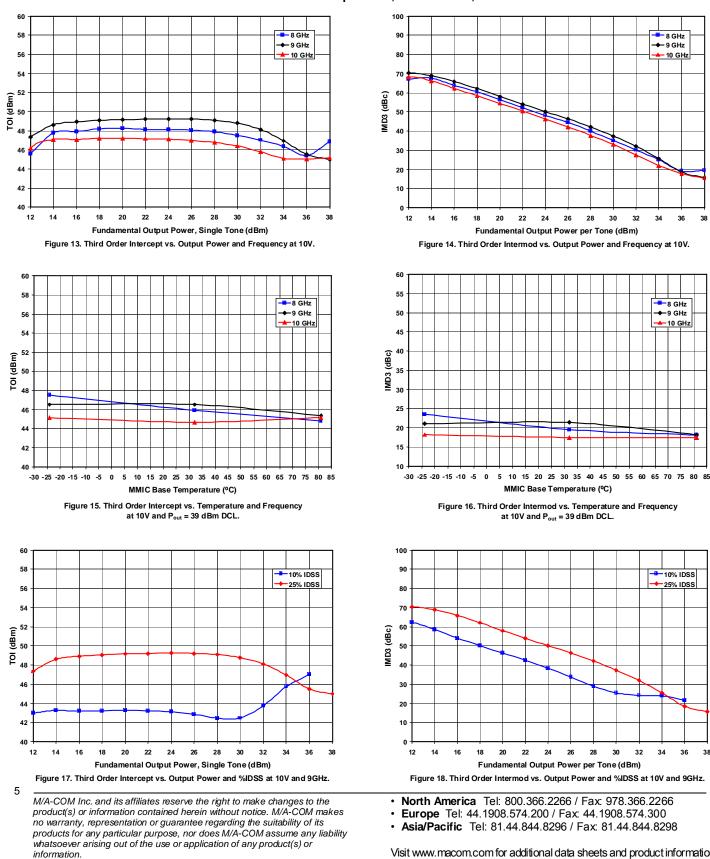
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#### MAAPGM0079-DIE Rev A **Preliminary Datasheet**

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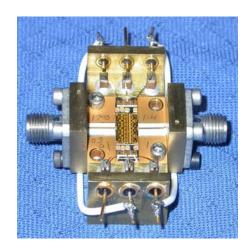


Figure 11. Fixture used to characterize MAAPGM0079-DIE under CW stimulus.

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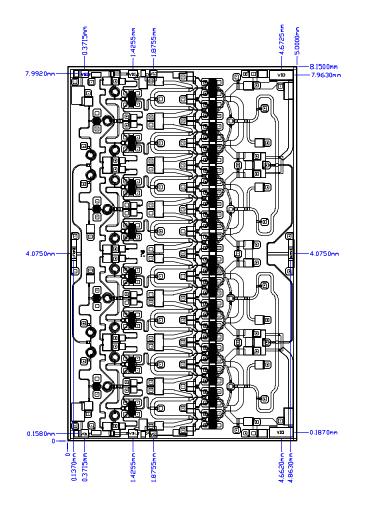
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# **Mechanical Information**

Chip Size: 5.000 x 8.150 x 0.075 mm (197 x 321 x 3 mils)



Chip edge to bond pad dimensions are shown to the center of the bond pad.

Figure 12. Die Layout

## **Bond Pad Dimensions**

| Pad                                | Size (µm) | Size (mils) |
|------------------------------------|-----------|-------------|
| RF In and Out                      | 100 x 200 | 4 x 8       |
| DC Drain Supply Voltage $V_{D1,2}$ | 200 x 150 | 8 x 6       |
| DC Drain Supply Voltage $V_{D3}$   | 500 x 200 | 20 x 8      |
| DC Gate Supply Voltage $V_{G1,2}$  | 150 x 150 | 6 x 6       |
| DC Gate Supply Voltage $V_{G3}$    | 150 x 125 | 6 x 5       |

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Electronics

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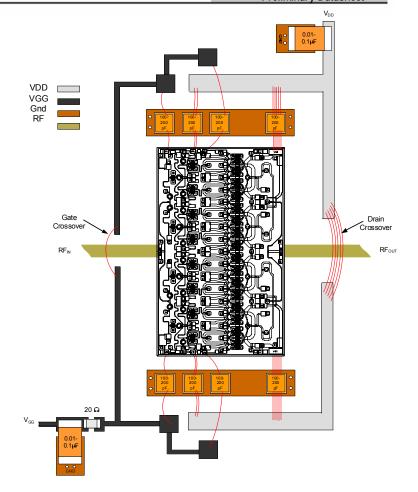
## Assembly and Bonding Diagram

#### Thermal Management is critical on this part. Refer to Application Note AN3019 for applicable guidelines.

NOTE 1: All Application Notes may be accessed by going to http://www.macom.com/ Application%20Notes/index.htm.

**NOTE 2:** In implementing the DC/ RF crossover shown, the following rules must applied.

- the DC crossovers should approach and 1. cross the RF trace at a 90 degree angle;
- 2. the printed DC traces that approach the RF line should be stopped 2 substrate heights from the RF line edge;
- 3. the rated current capability of the DC crossovers should be greater than the maximum current of the device; and
- 4. the wires or ribbons used to make the DC crossovers should clear the RF trace by ~ 1 substrate height.



#### Figure 13. Recommended operational configuration. Wire bond as shown.

## **Die Handling:**

Refer to Application Note AN3016.

## **Assembly Instructions:**

Die Attach: Use AuSn (80/20) 1 mil. preform solder. Limit time @ 310 °C to less than 7 minutes. Refer to Application Note AN3017 for more detailed information.

Wirebonding: Bond @ 160 °C using standard ball or thermal compression wedge bond techniques. For DC pad connections, use either ball or wedge bonds. For best RF performance, use wedge bonds of shortest length, although ball bonds are also acceptable.

#### Biasing Note: Must apply negative bias to V<sub>GG</sub> before applying positive bias to V<sub>DD</sub> to prevent damage to amplifier.



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